T-1 (3mm) BI-LEVEL LED INDICATOR

Part Number: WP130WCP/2EYW

High Efficiency Red Yellow

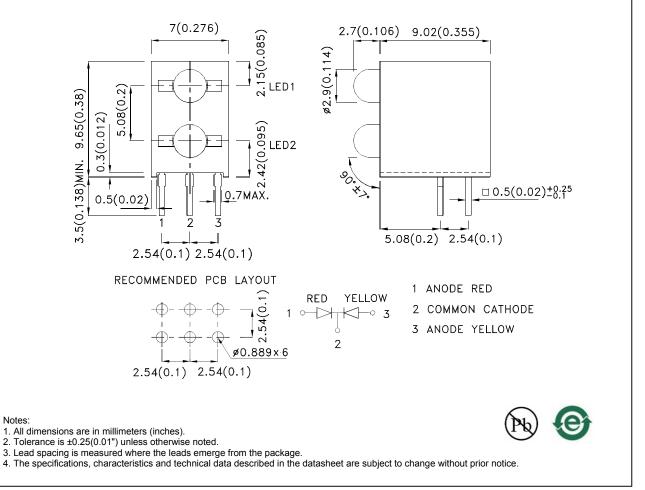
Features

- Bi-level right angle housing LED.
- Pre-trimmed leads for pc board mounting.
- Black case enhances contrast ratio.
- High reliability.
- Housing UL rating:94V-0.
- Housing material: type 66 nylon.
- RoHS compliant.

Descriptions

- The High Efficiency Red source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Orange Light Emitting Diode.
- The Yellow source color devices are made with Gallium Arsenide Phosphide on Gallium Phosphide Yellow Light Emitting Diode.

Package Dimensions



SPEC NO: DSAF1891 APPROVED: WYNEC REV NO: V.6A CHECKED: Allen Liu DATE: MAR/16/2015 DRAWN: P.Cheng PAGE: 1 OF 6 ERP: 1102000163

Salaction Guida

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
		51	Min.	Тур.	201/2
WP130WCP/2EYW	High Efficiency Red (GaAsP/GaP)	White Diffused	12	30	60°
			*10	*24	
	Yellow (GaAsP/GaP)		10	20	
			*10	*20	

Notes:

θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
Luminous intensity/ luminous Flux: +/-15%.
*Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions	
λpeak	Peak Wavelength	High Efficiency Red Yellow	627 590		nm IF=20mA		
λD [1]	Dominant Wavelength	High Efficiency Red Yellow	617 588		nm	I⊧=20mA	
Δλ1/2	Spectral Line Half-width	High Efficiency Red Yellow	45 35		nm	IF=20mA	
С	Capacitance	High Efficiency Red Yellow	15 20		pF	VF=0V;f=1MHz	
Vf [2]	Forward Voltage	High Efficiency Red Yellow	2 2.1	2.5 2.5	V	I⊧=20mA	
lr	Reverse Current	High Efficiency Red Yellow		10 10	uA	uA VR = 5V	

Notes:

1. Wavelength: +/-1nm.

2. Forward Voltage: +/-0.1V.

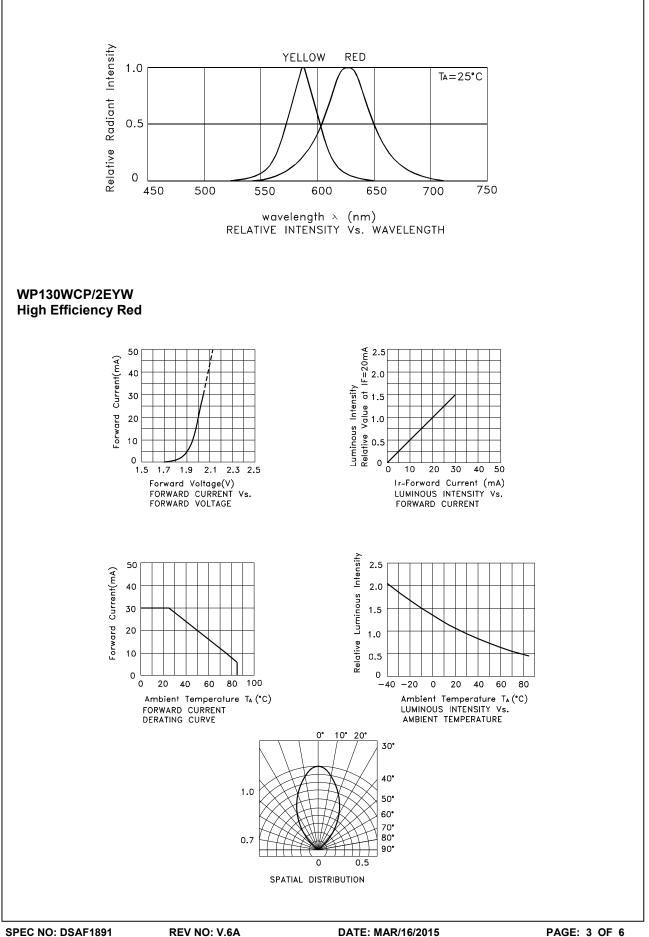
Wavelength value is traceable to the CIE127-2007 compliant national standards.
Excess driving current and/or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

Absolute Maximum Ratings at TA=25°C

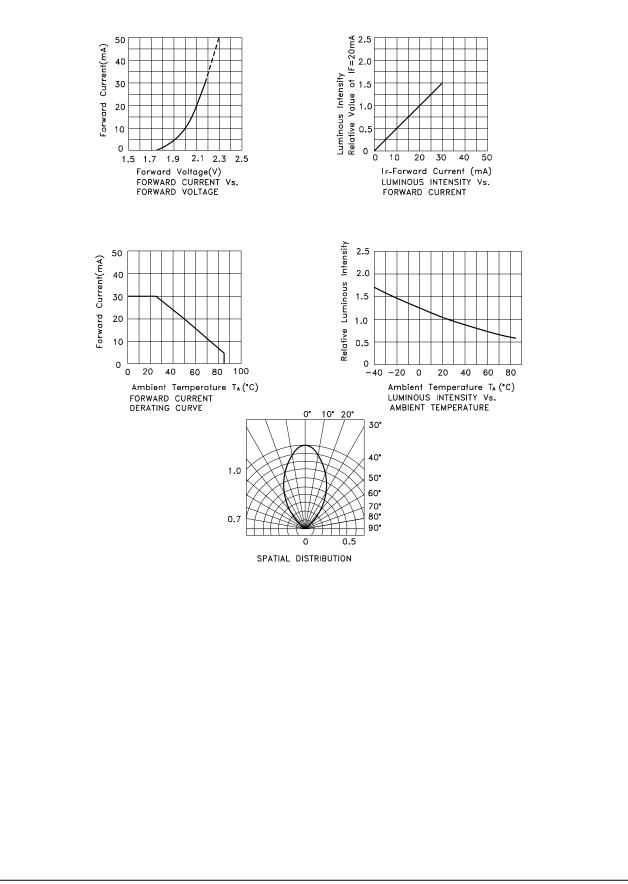
Parameter	High Efficiency Red	Yellow	Units		
Power dissipation	75	75	mW		
DC Forward Current	30	30	mA		
Peak Forward Current [1]	160	140	mA		
Reverse Voltage		V			
Operating / Storage Temperature	-40°C To +85°C				
Lead Solder Temperature [2]	260°C For 3 Seconds				
Lead Solder Temperature [3]	260°C For 5 Seconds				
Notes [.]					

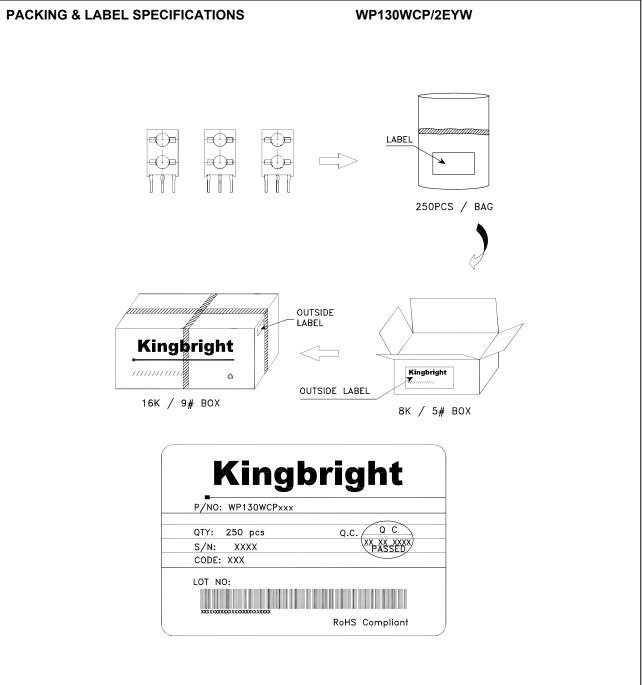
Notes

1.1/10 Duty Cycle, 0.1ms Pulse Width.
2.2mm below package base.
3.5mm below package base.



Yellow





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PRECAUTIONS

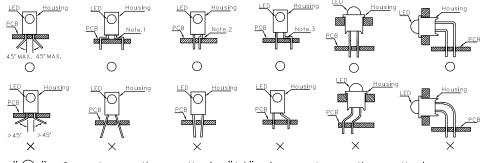
1. Storage conditions:

a.Avoid continued exposure to the condensing moisture environment and keep the product away from rapid transitions in ambient temperature.

b.LEDs should be stored with temperature \leq 30°C and relative humidity <60%.

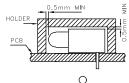
c.Product in the original sealed package is recommended to be assembled within 72 hours of opening. Product in opened package for more than a week should be baked for 30 (+10/-0) hours at $85 \sim 100^{\circ}$ C.

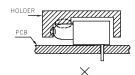
2. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures.



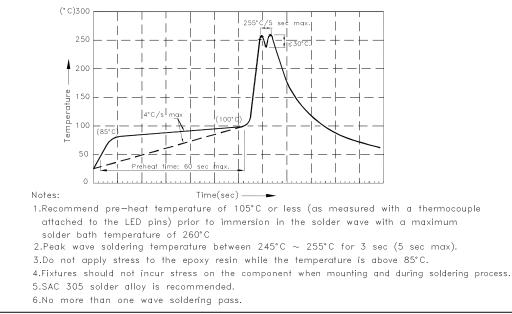
"○" Correct mounting method "×" Incorrect mounting method Note 1-3: Do not route PCB trace in the contact area between the leadframe and the PCB to prevent short-circuits.

3. During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.





- 4. The tip of the soldering iron should never touch the lens epoxy.
- 5. Through-hole LEDs are incompatible with reflow soldering.
- 6. If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.
- 7. Recommended Wave Soldering Profiles:



SPEC NO: DSAF1891 APPROVED: WYNEC REV NO: V.6A CHECKED: Allen Liu DATE: MAR/16/2015 DRAWN: P.Cheng PAGE: 6 OF 6 ERP: 1102000163

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